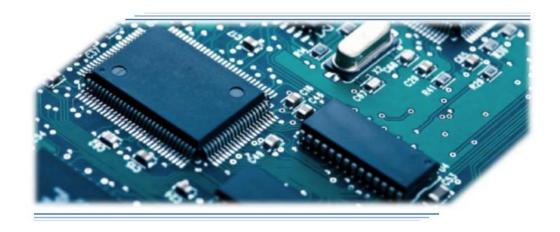
Eclipse GCC 安装与使用 V0.2



上海复旦微电子集团股份有限公司

Shanghai Fudan Microelectronics Group Company Limited

开发者论坛: http://www.fmdevelopers.com.cn

概述

Eclipse 是开源免费的集成开发环境,GCC 是编译 C/C++的开源免费编译器套件。使用 Eclipse+GCC 可以为嵌入式开发人员提供免费的 C/C++的编译和调试环境。本文主要描述在 windows7 环境下安装使用 Eclipse+GCC 开发复旦微芯片的流程。

版本

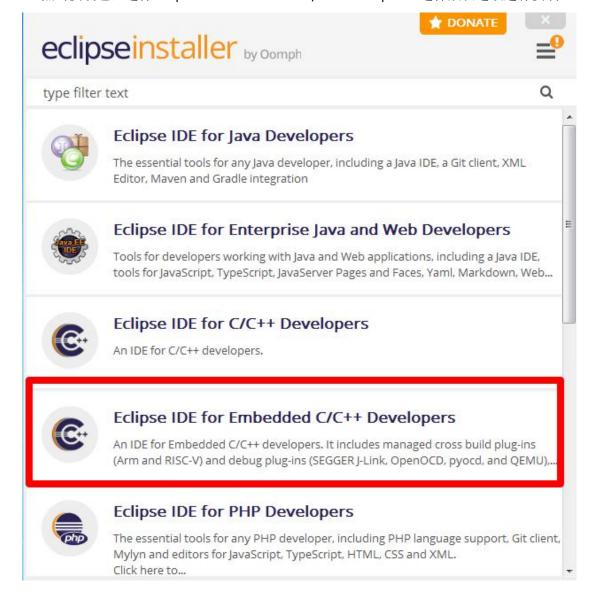
版本	时间	修改内容
初版	2021.6.11	
V0.1	2021.6.30	1 增加工程配置参数中 build steps 配置 2 增加 DEBUG 参数配置中 Startup 配置 3 增加仿真时显示外设寄存器窗
		口的步骤 4 修改 JLINK 工具软件版本
V0.2	22021.9.13	1 增加 DEBUG 参数配置中 FLASH 擦除命令的注释

软件安装

1 Eclipse 安装

下载地址: https://www.eclipse.org/downloads/

点击安装包,选择 Eclipse IDE for Embedded C/C++ Developers,选择默认选项进行安装。



2 gcc-arm-none-eabi 安装

下载地址:

https://developer.arm.com/tools-and-software/open-source-software/developer-tools/gnu-toolchain/gnu-rm/downloads

选择默认选项进行安装,在点击完成前注意在添加路径到环境变量前打勾。



3 JlinkGDBServer

建议使用 V680 以上版本,可到 SEGGER 官网下载。安装 SEGGER 后,在 jlink 软件中增加我司芯片型号,安装方法可以参考我司开发者论坛:

http://www.fmdevelopers.com.cn/forum.php?mod=viewthread&tid=2102&extra=page%3D1

4 windows build tools

下载地址: https://xpack.github.io/windows-build-tools/releases/

The xPack Windows Build Tools releases

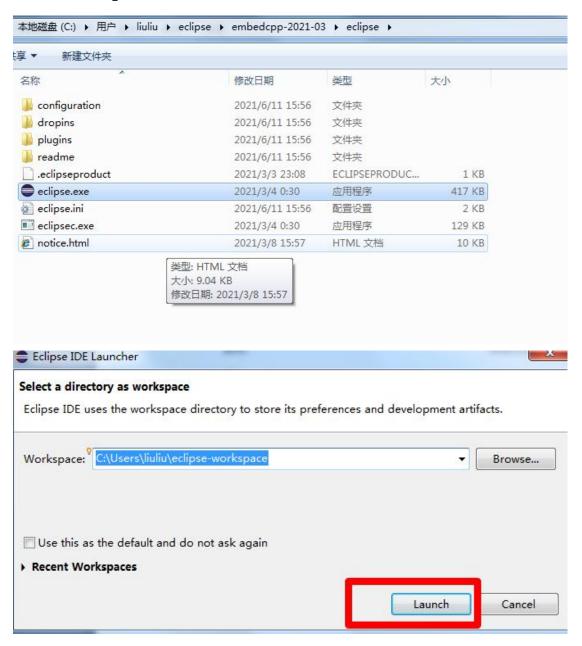
- xPack Windows Build Tools v4.2.1-2 released (download)
- xPack vvindows Build Tools v4.2.1-1 released (download)
- xPack Windows Build Tools v2.12.2 released (download)
- GNU MCU Eclipse Windows Build Tools v2.12 20190422 released (download)
- . GNU MCU Eclipse Windows Build Tools v2.11-20180428 released (download)
- GNU MCU Eclipse Windows Build Tools v2.10-20180103 released (download)
- GNU MCU Eclipse Windows Build Tools v2.9-20170629 released (download)
 GNU ARM Eclipse Windows Build Tools v2.8-20161122* released (download)
- GNU ARM Eclipse Windows Build Tools v2.7-20161028* released (download)
 GNU ARM Eclipse Windows Build Tools v2.7-20161028* released (download)
- GNU ARM Eclipse Windows Build Tools v2.6-20150715* released (download)
- GNU ARM Eclipse Windows Build Tools v2.4-20150324* released (download)
- GNU ARM Eclipse Windows Build Tools v2.4-20150321* released (download)
- ONO ARM Eclipse Williams Build Tools V2.4-20130321 Teleased (download)
- GNU ARM Eclipse Windows Build Tools v2.3-20150124* released (download)
- GNU ARM Eclipse Windows Build Tools v2.2-20150123* released (download)
- GNU ARM Eclipse Windows Build Tools v2.1-20150122* released (download)
- · Build Tools repacked as Setup (download)

解压缩下载文件后,将文件复制到 GNU Arm Embedded Toolchain 目录下



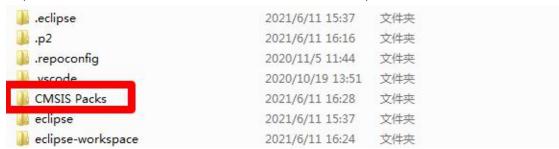
eclipse 配置

1 启动 eclipse



2添加芯片 pack

Eclipse 文件夹同一目录下新建 CMSIS Packs 文件夹用于存放 pack 信息

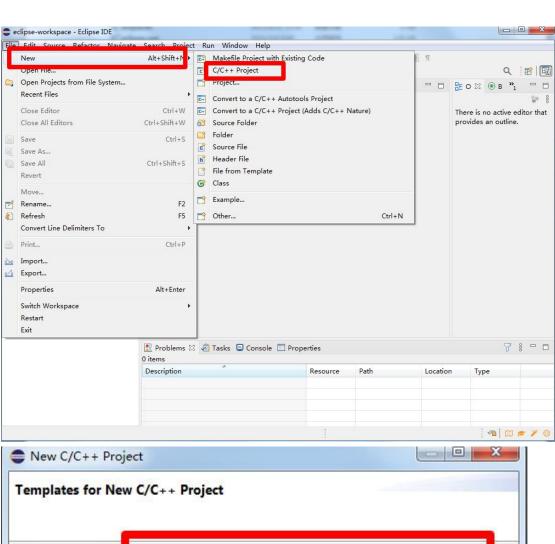


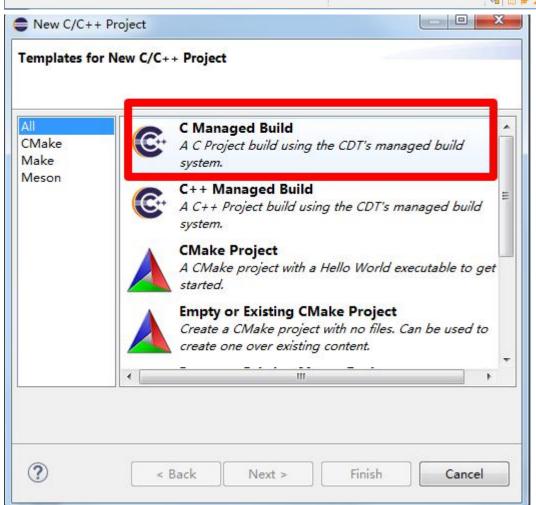
芯片 pack 文件复制到 CMSIS Packs 文件夹

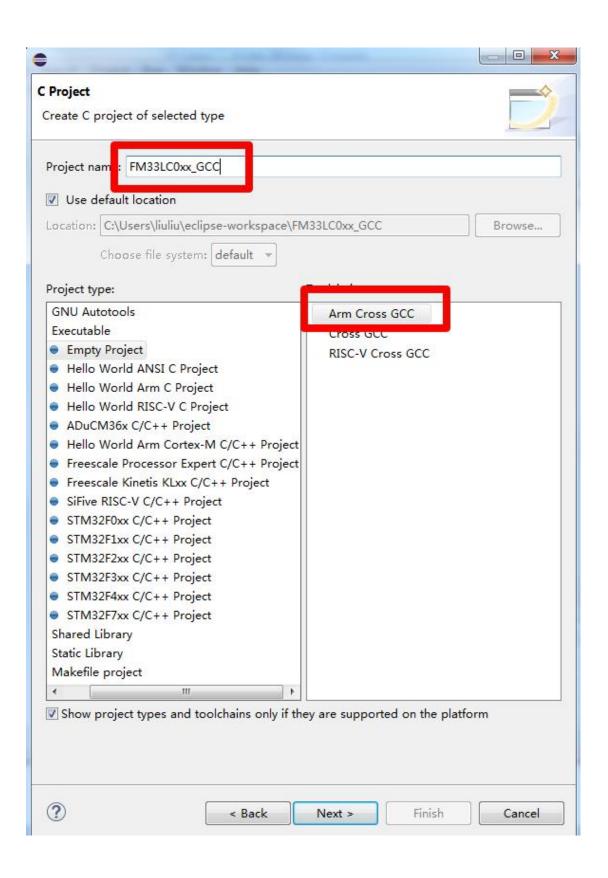


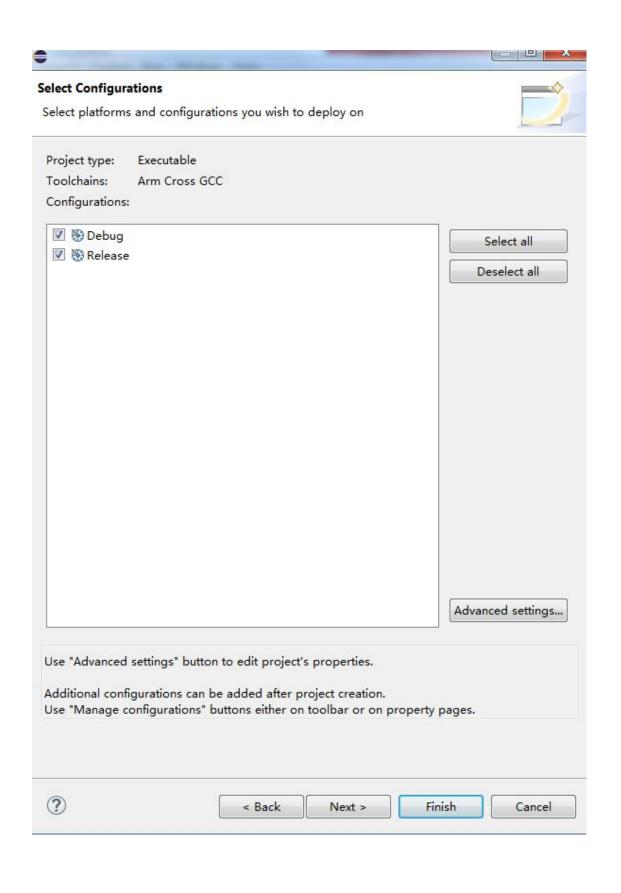
3 建立 C Project

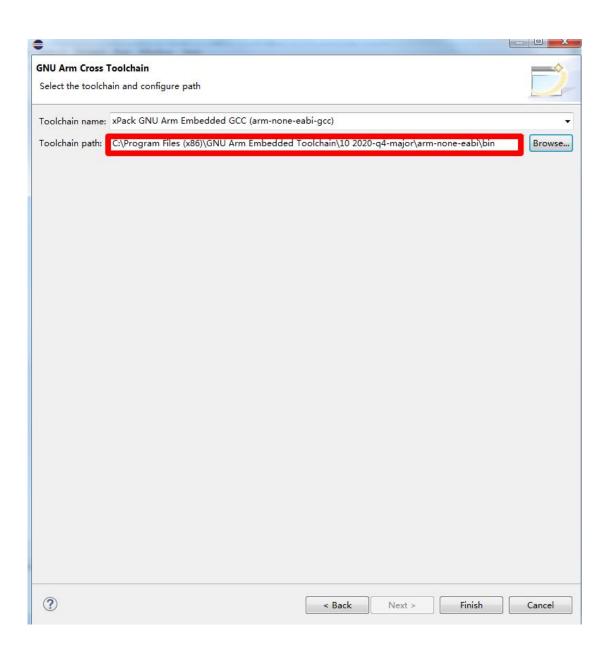
点击 File->New->C/C++ Project

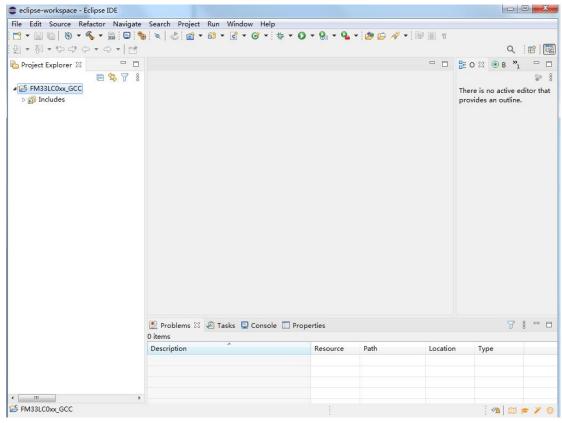




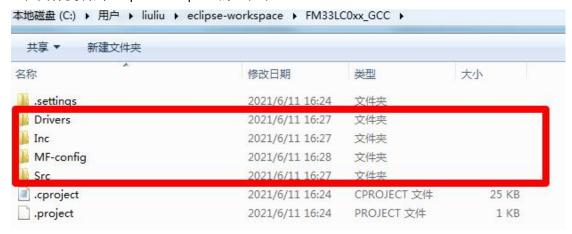




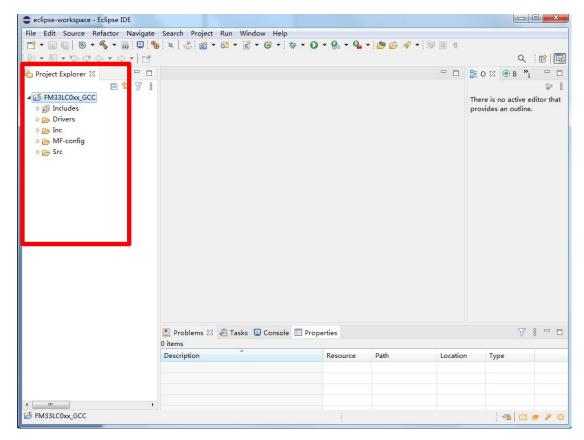




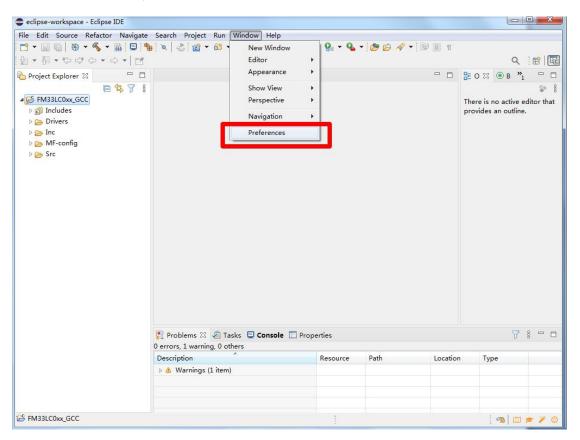
工程文件复制到 eclipse-workspace 的工程中

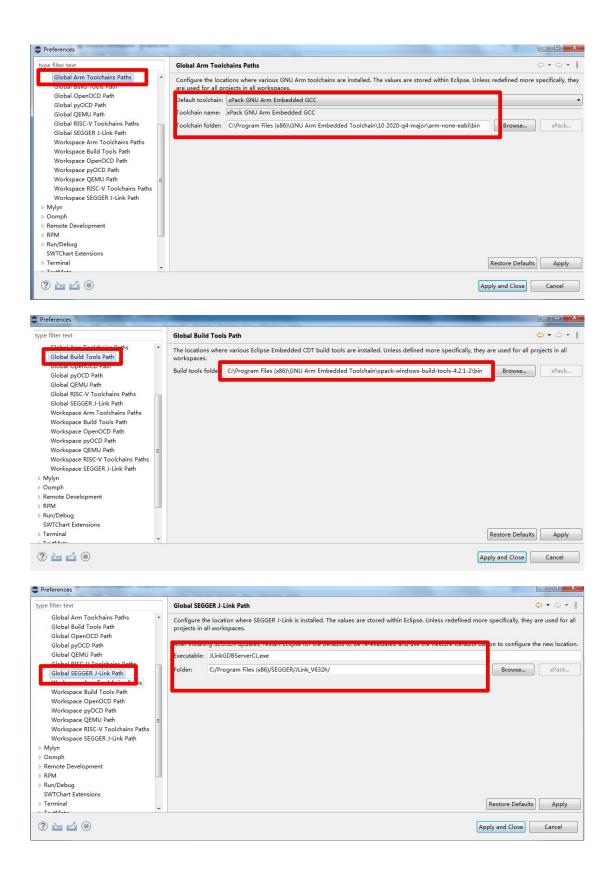


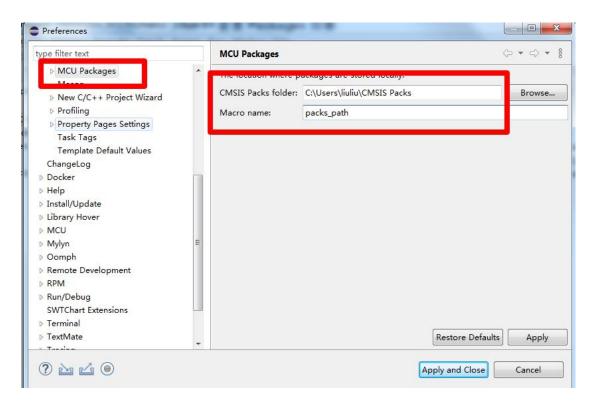
在 eclipse 软件中按 F5,程序自动更新



4 设置系统参数

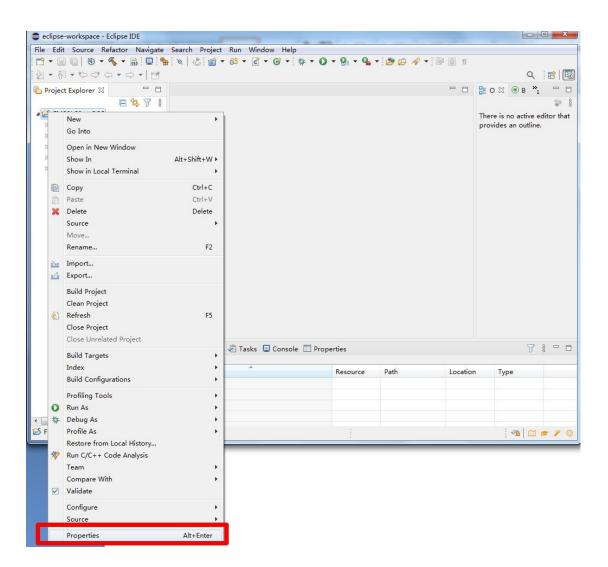


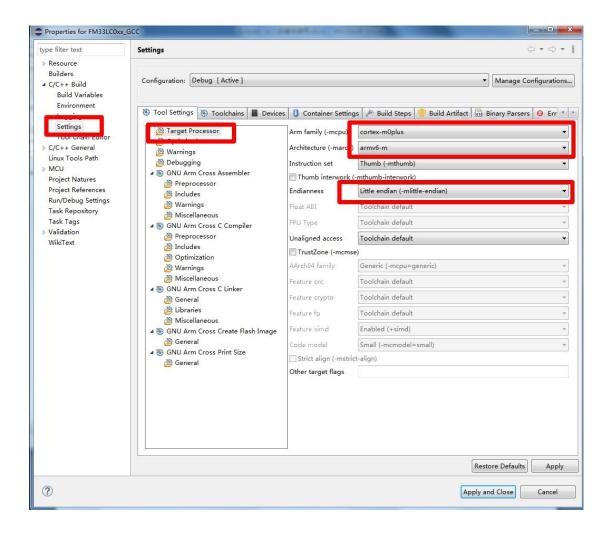


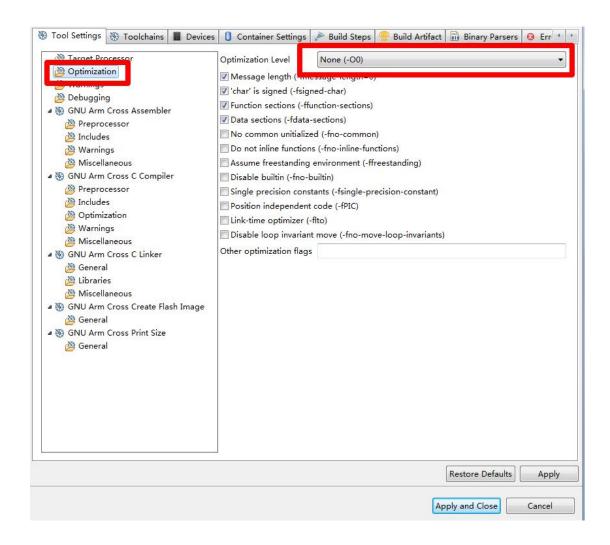


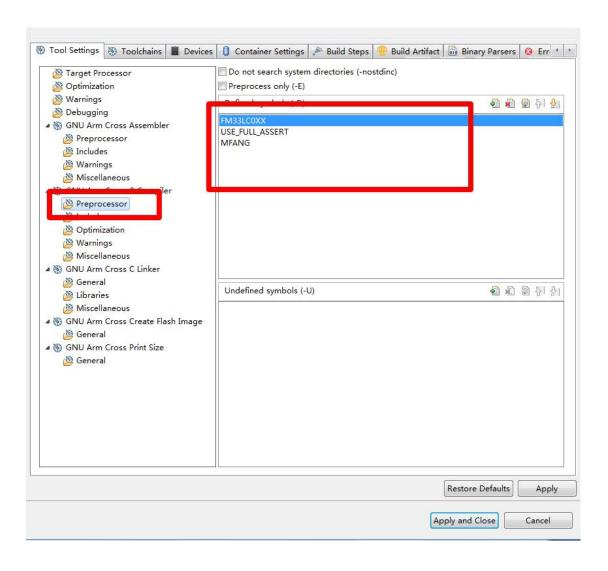
5 工程参数配置

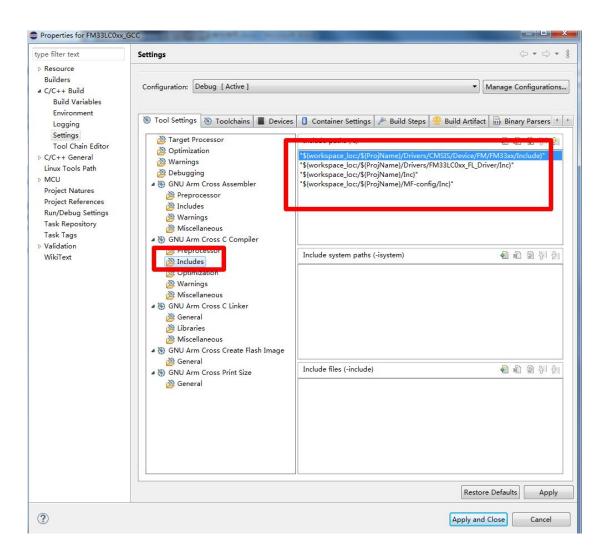
选择工程名点击右键选择 properties

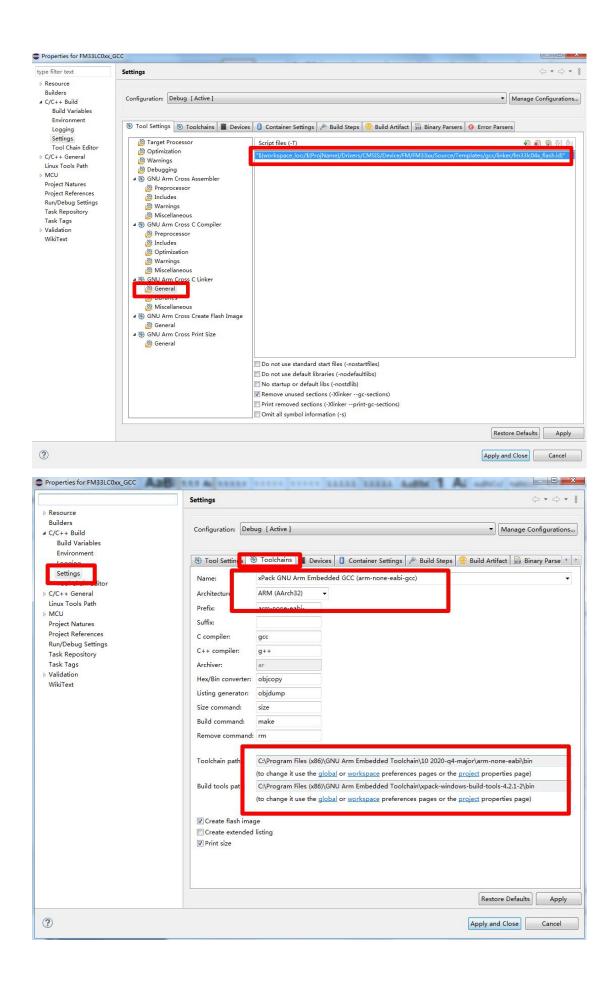


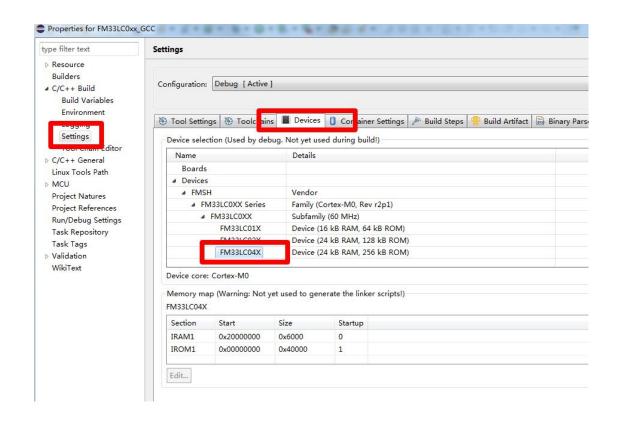


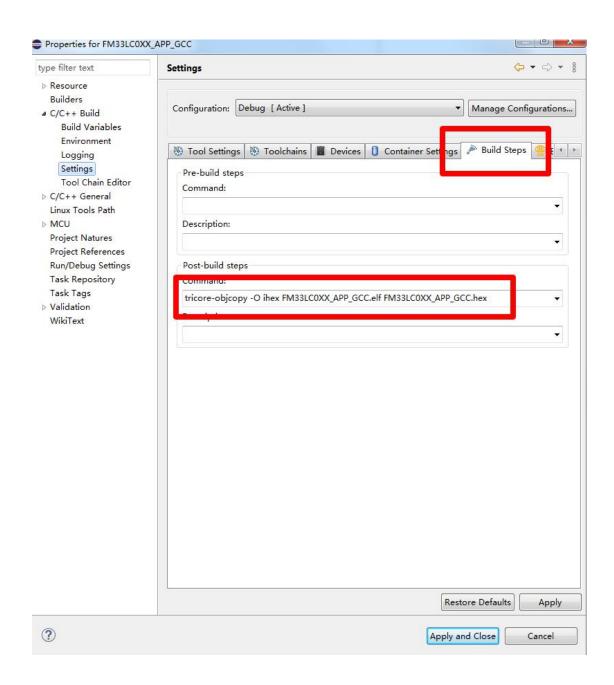




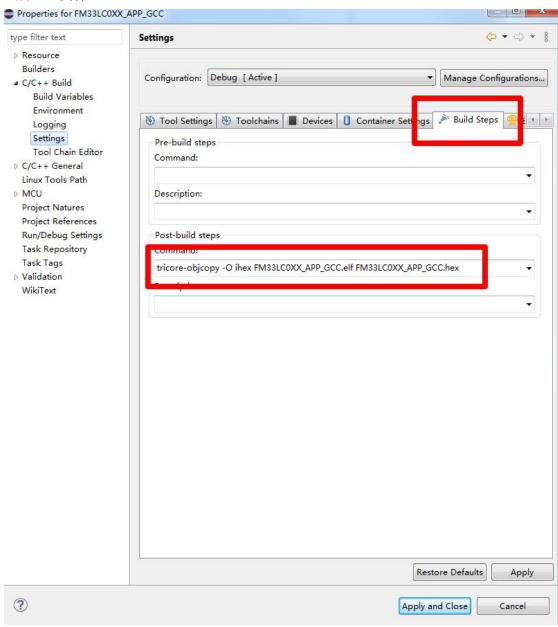




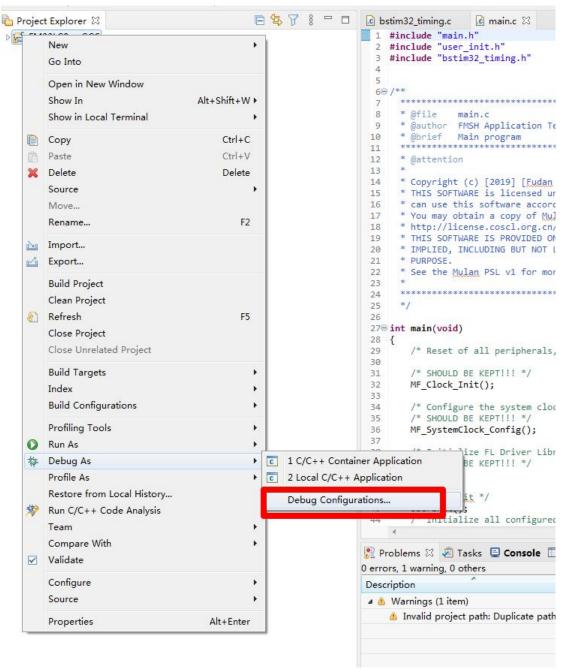




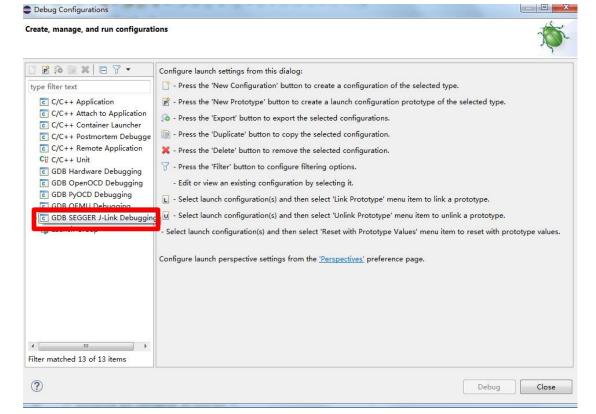
生成 HEX 文件



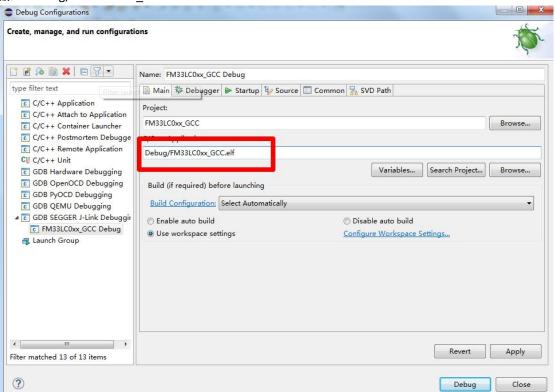
6 DEBUG 参数配置

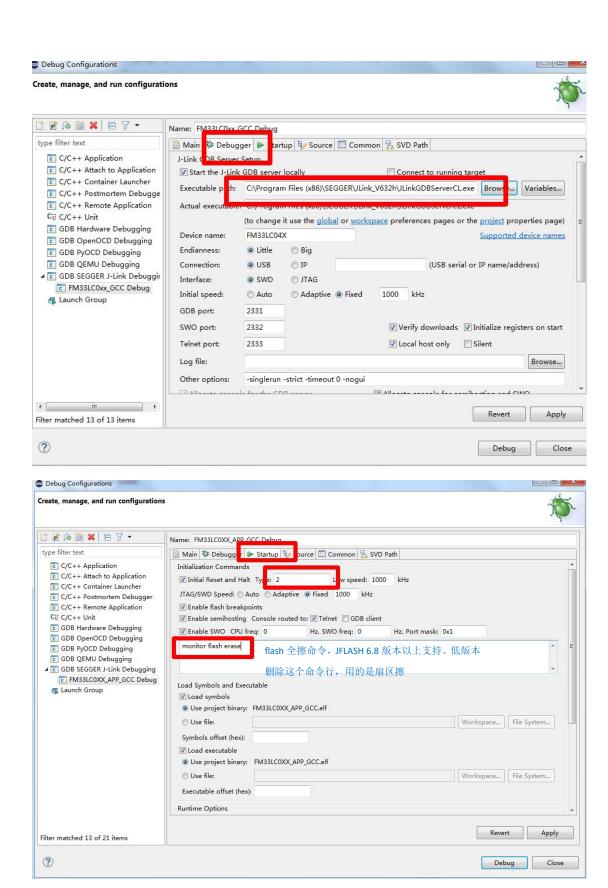


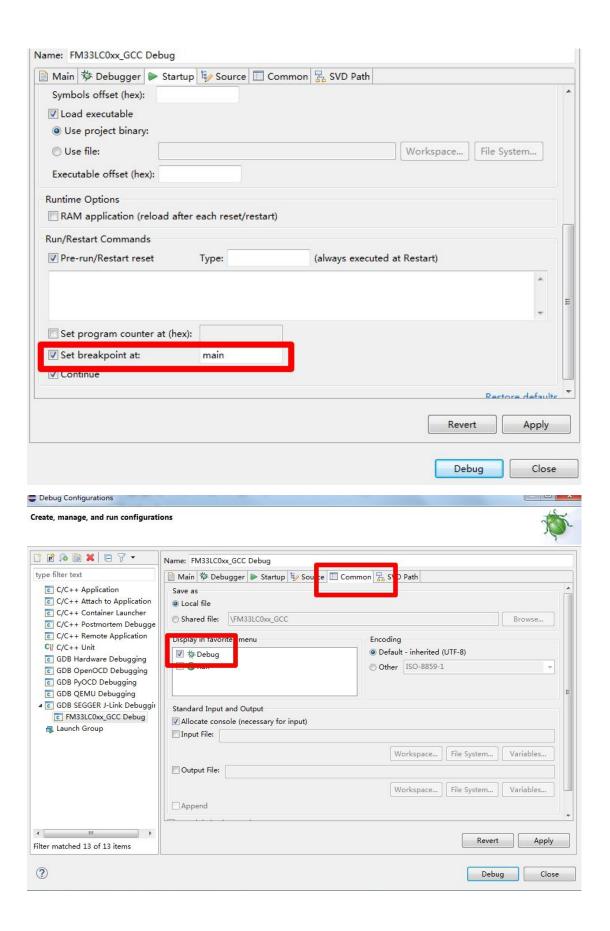
双击 GDB SEGGER JLINK DEBUGGING

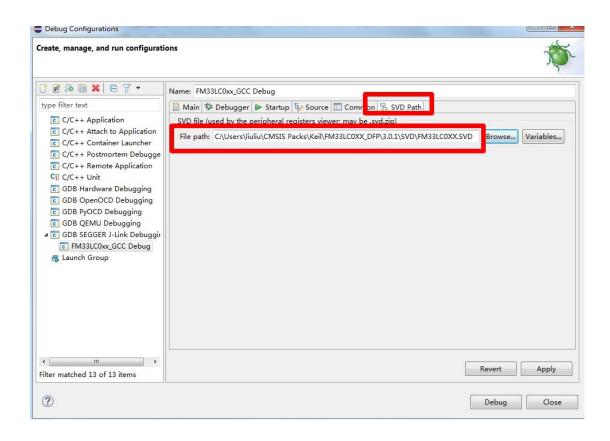


输入 Debug/FM33LC0xx_GCC.elf



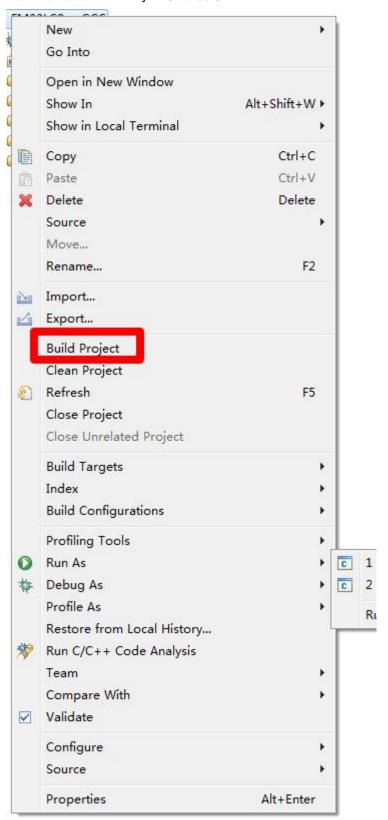






编译和仿真

工程右键单击 Build Project 执行编译



点击 DEBUG 符号进入仿真界面

